



# SPP7401

## P-Channel Enhancement Mode MOSFET

### DESCRIPTION

The SPP7401 is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density , DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits where high-side switching , and low in-line power loss are needed in a very small outline surface mount package.

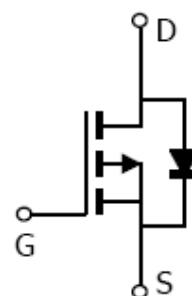
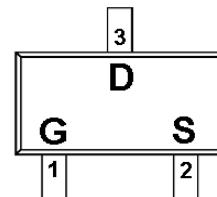
### APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

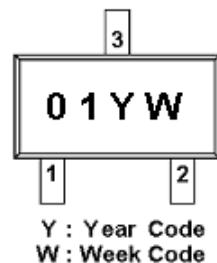
### FEATURES

- ◆ -30V/-2.8A,R<sub>DS(ON)</sub>=115mΩ@V<sub>GS</sub>=-10V
- ◆ -30V/-2.5A,R<sub>DS(ON)</sub>=125mΩ@V<sub>GS</sub>=-4.5V
- ◆ -30V/-1.5A,R<sub>DS(ON)</sub>=170mΩ@V<sub>GS</sub>=-2.5V
- ◆ -30V/-1.0A,R<sub>DS(ON)</sub>=240mΩ@V<sub>GS</sub>=-1.8V
- ◆ Super high density cell design for extremely low RDS ( ON )
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ SOT-323 ( SC-70 ) package design

### PIN CONFIGURATION ( SOT-323 ; SC-70 )



### PART MARKING





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### PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

### ORDERING INFORMATION

Part Number	Package	Part Marking
SPP7401S32RG	SOT-323	01YW
SPP7401S32RGB	SOT-323	01YW

※ Week Code : A ~ Z( 1 ~ 26 ) ; a ~ z( 27 ~ 52 )

※ SPP7401S32RG : Tape Reel ; Pb – Free

※ SPP7401S32RGB : Tape Reel ; Pb – Free ; Halogen -Free

### ABSOLUTLE MAXIMUM RATINGS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V <sub>DSS</sub>	-30	V
Gate –Source Voltage	V <sub>GSS</sub>	±12	V
Continuous Drain Current(T <sub>J</sub> =150°C)	T <sub>A</sub> =25°C	ID	-2.8
	T <sub>A</sub> =70°C		-2.1
Pulsed Drain Current	I <sub>DM</sub>	-8	A
Continuous Source Current(Diode Conduction)	I <sub>S</sub>	-1.4	A
Power Dissipation	T <sub>A</sub> =25°C	P <sub>D</sub>	0.33
	T <sub>A</sub> =70°C		0.21
Operating Junction Temperature	T <sub>J</sub>	-55/150	°C
Storage Temperature Range	T <sub>STG</sub>	-55/150	°C
Thermal Resistance-Junction to Ambient	R <sub>θJA</sub>	105	°C/W



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### ELECTRICAL CHARACTERISTICS

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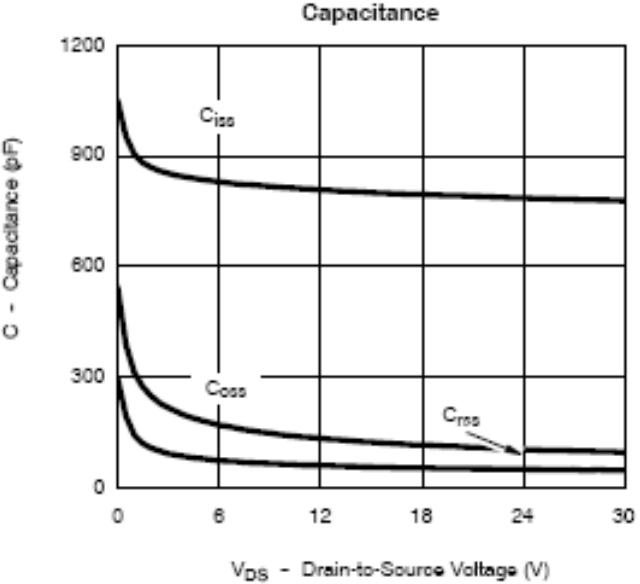
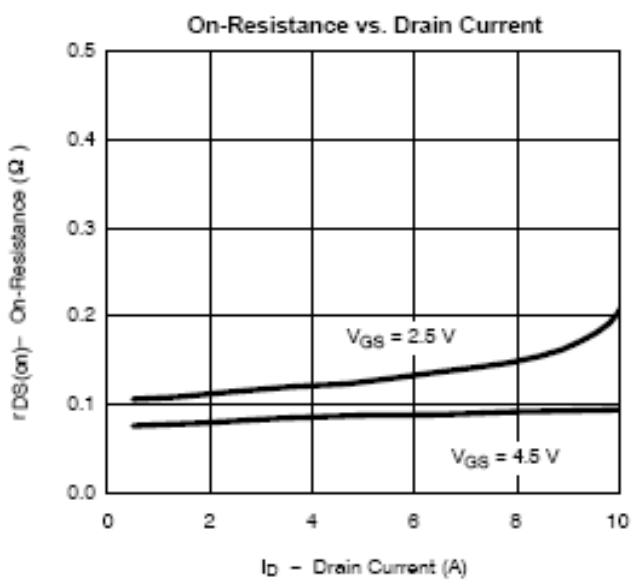
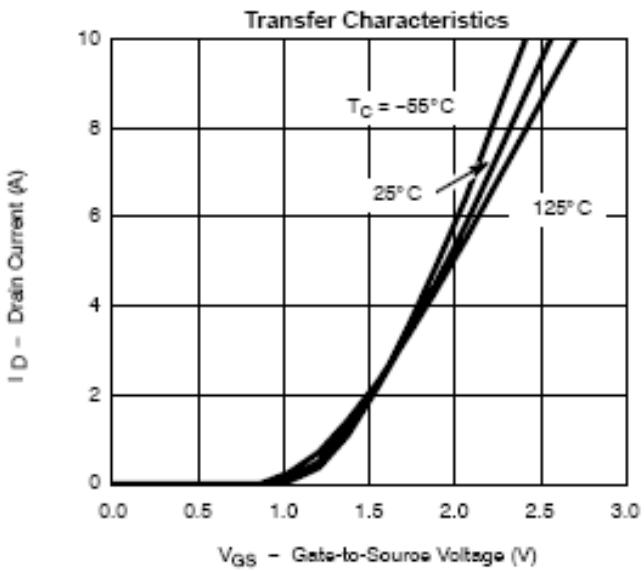
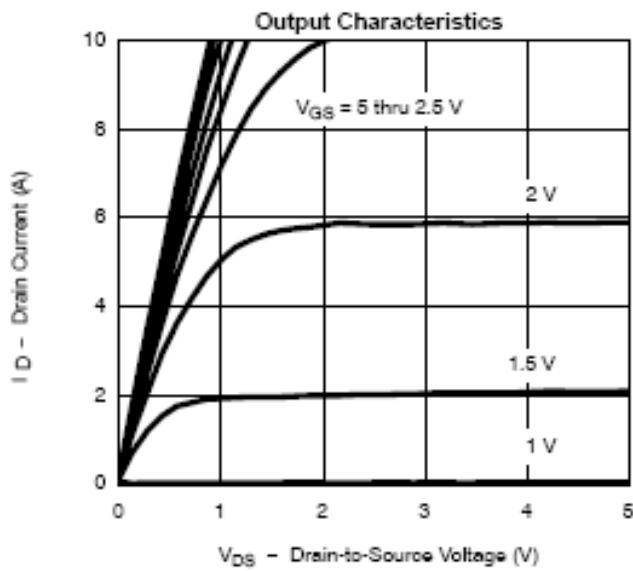
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, ID=-250uA	-30			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , ID=-250uA	-0.4		-1.0	
Gate Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±12V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V			-1	
		V <sub>DS</sub> =-24V, V <sub>GS</sub> =0V T <sub>J</sub> =85°C			-5	uA
On-State Drain Current	I <sub>D(on)</sub>	V <sub>DS</sub> = -5V, V <sub>GS</sub> =-4.5V	-4			A
Drain-Source On-Resistance	R <sub>D(on)</sub>	V <sub>GS</sub> =-10V, ID=-2.8A		0.105	0.115	
		V <sub>GS</sub> =-4.5V, ID=-2.5A		0.125	0.135	
		V <sub>GS</sub> =-2.5V, ID=-1.5A		0.155	0.170	
		V <sub>GS</sub> =-1.8V, ID=-1.0A		0.210	0.240	
Forward Transconductance	g <sub>fs</sub>	V <sub>DS</sub> =-10V, ID=-2.8A		4		S
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =-1.2A, V <sub>GS</sub> =0V		-0.8	-1.2	V
<b>Dynamic</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =-15V , V <sub>GS</sub> =-4.5V ID=-2.0A		5.8		
Gate-Source Charge	Q <sub>gs</sub>			0.8		nC
Gate-Drain Charge	Q <sub>gd</sub>			1.5		
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V f=1MHz		380		
Output Capacitance	C <sub>oss</sub>			55		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			40		
Turn-On Time	t <sub>d(on)</sub>	V <sub>DD</sub> =-15V , R <sub>L</sub> =15Ω ID=-1.0A , V <sub>GEN</sub> =-10V R <sub>G</sub> =3Ω		6		
	t <sub>r</sub>			3.9		ns
Turn-Off Time	t <sub>d(off)</sub>			40		
	t <sub>f</sub>			15		



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### TYPICAL CHARACTERISTICS

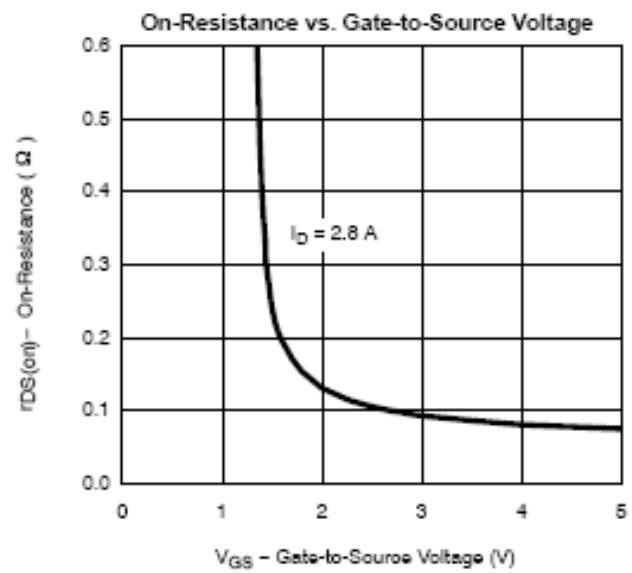
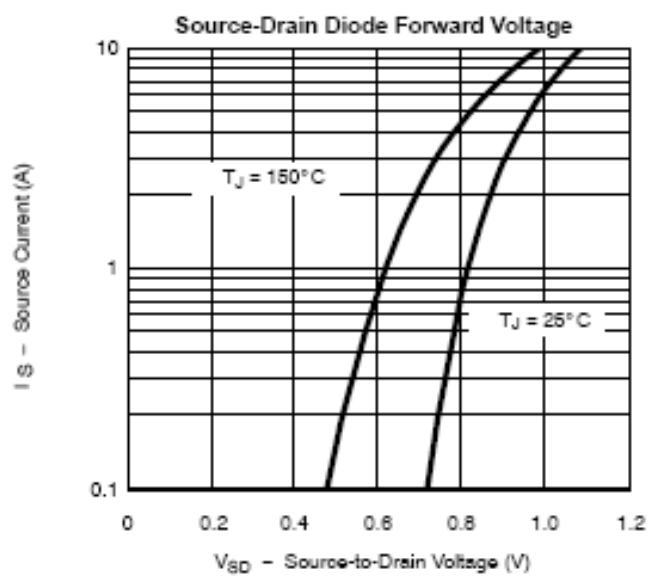
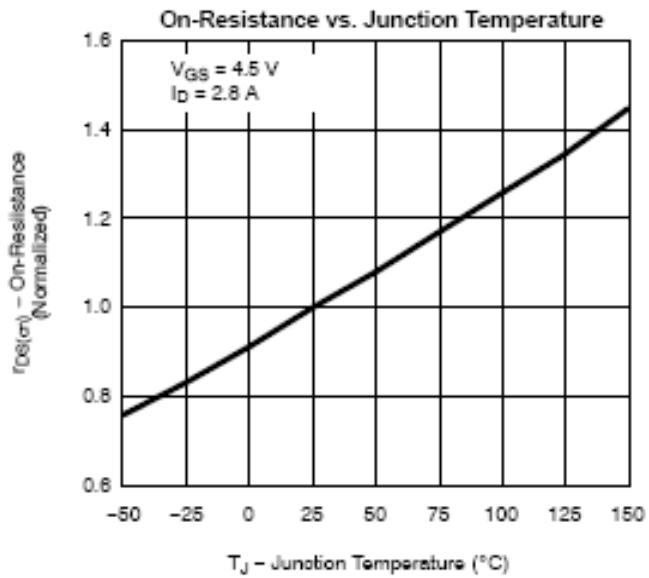
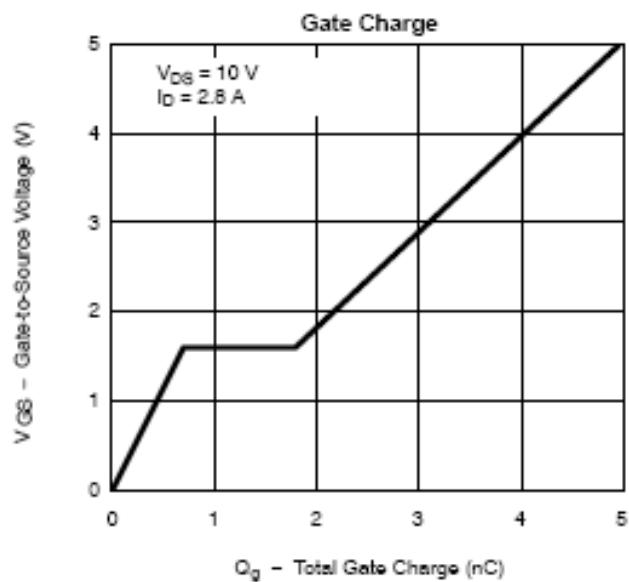




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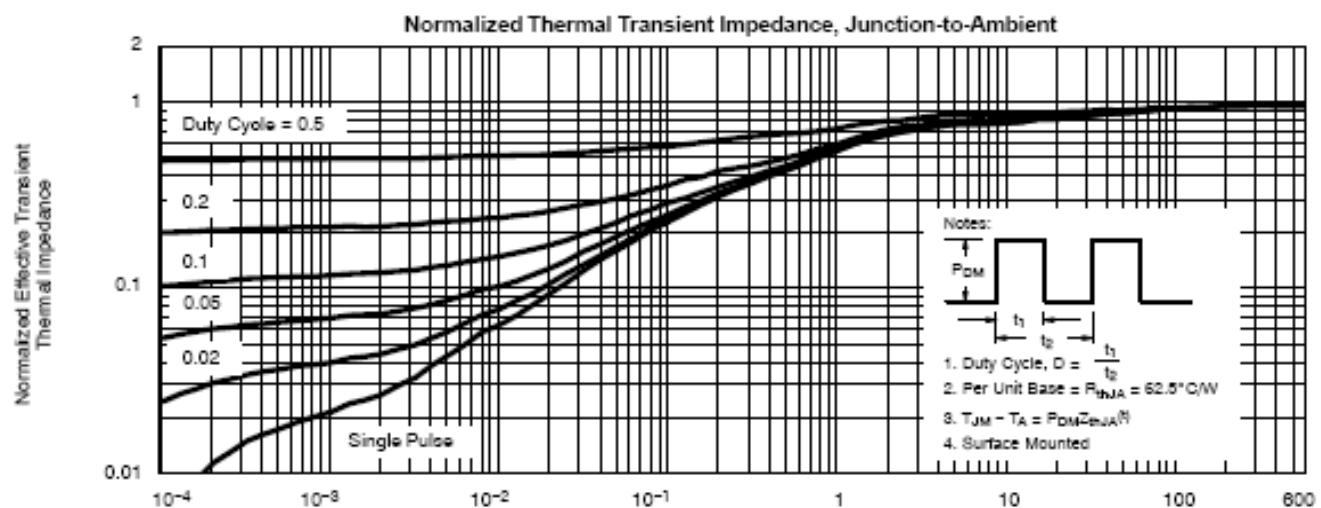
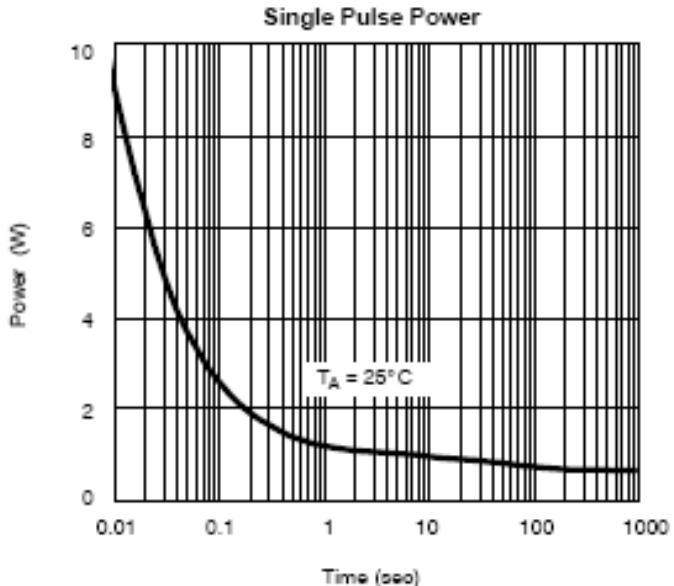
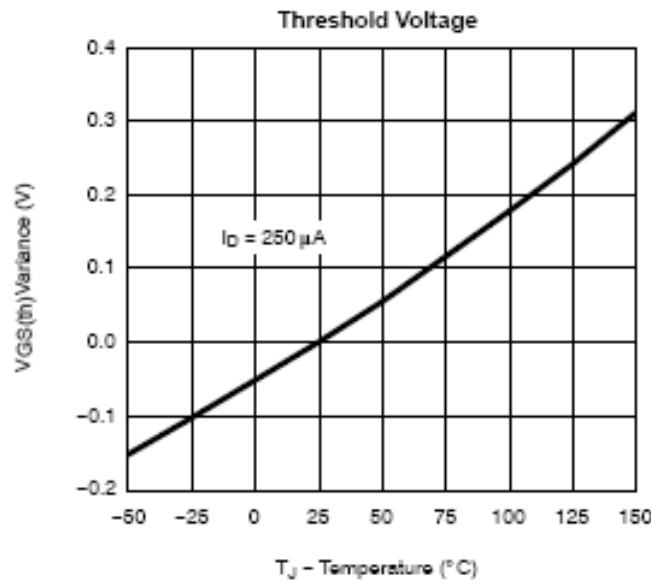
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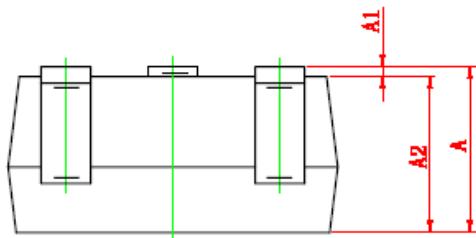
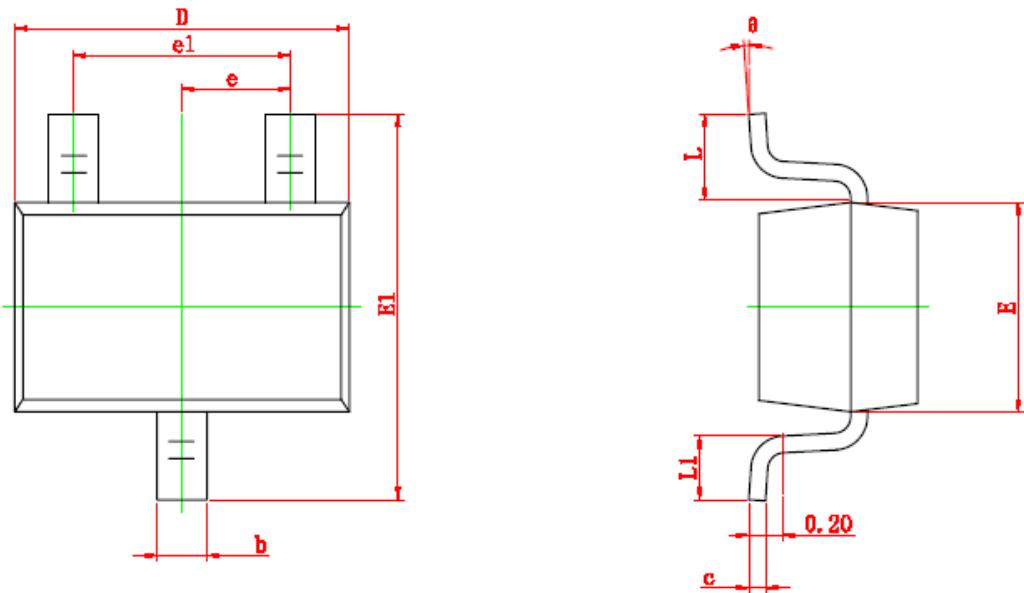




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### SOT-323 PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP		0.026 TYP	
e1	1.200	1.400	0.047	0.055
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
θ	0°	8°	0°	8°



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